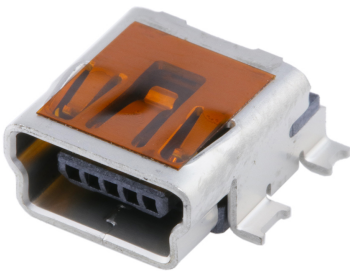




**Part Number :** [548191572](#)  
**Product Description :** Mini USB, B-Receptacle, Right-Angle, Surface Mount Solder Tails and Shell Tabs, with Cover Tape, Lead-Free, LCP Housing  
**Series Number :** 54819  
**Status :** Active  
**Product Category :** I/O Connectors



Documents & Resources


**Drawings**  
[548191572\\_sd.pdf](#)  
[54819025-SPK-000.pdf](#)

**3D Models and Design Files**  
[548191572\\_stp.zip](#)

**Specifications**  
[PS-54819-011-001.pdf](#)  
[PS-54819-012-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)7663-DC (21 Jan 2025)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements  
- Eu RoHS  
- REACH SVHC  
- Low-Halogen

Multiple Part Industry Compliance Documents  
- IPC 1752A Class C

- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

## EU RoHS Certificate of Compliance

---

### Part Details

#### General

Status	Active
Category	I/O Connectors
Series	54819
Description	Mini USB, B-Receptacle, Right-Angle, Surface Mount Solder Tails and Shell Tabs, with Cover Tape, Lead-Free, LCP Housing
Application	Wire-to-Board
Component Type	Receptacle
Product Name	USB
Standard	USB 2.0
Type	Mini-B
UPC	822348178834

#### Agency

UL	E29179
----	--------

#### Electrical

Current - Maximum per Contact	1.0A
Shielded	Yes
Voltage - Maximum	30V

#### Physical

Circuits (Loaded)	5
Circuits (maximum)	5
Color - Resin	Black
Durability (mating cycles max)	5000
Flammability	94V-0

Gender	Female
Lock to Mating Part	Yes
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Mounting Style	Top-Mount
Net Weight	0.600/g
Orientation	Right Angle
Packaging Type	Embossed Tape on Reel
Panel Mount	No
PCB Locator	No
PCB Retention	Yes
Pitch - Mating Interface	0.80mm
Plating min - Mating	0.762µm
Plating min - Termination	1.016µm
Polarized to Mating Part	Yes
Temperature Range - Operating	-20° to +85°C
Termination Interface Style	Surface Mount
Waterproof / Dustproof	No

## Solder Process Data

Max-Duration	3
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	250